

AMENDMENTS TO THE SPECIFICATION

Please replace the title of the specification with the following amended title:

--DIFFUSION BARRIER LAYERS AND ~~METHODS PROCESSES COMPRISING~~ FOR
DEPOSITING METAL FILMS THEREUPON BY CVD OR ALD PROCESSES—

Please replace paragraph [0001] the following amended paragraph:

[0001] This application is a continuation-in-part of U.S. Patent ~~Application No. 10/428,447-~~
No. 7,311,946, filed 2 May 2003, and issued December 25, 2007, the disclosure of which is
incorporated herein by reference in its entirety.